

TO

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					△				
△					△				
APPLICABLE STANDARD									
RATING	OPERATING TEMPERATURE RANGE	-30 °C TO +85 °C(NOTE1)			STRAGE TEMPERATURE RANGE	-10 °C TO +60 °C(NOTE2)			
	OPERATING HUMIDITY RANGE	20 % TO 80 %			STRAGE HUMIDITY RANGE	40 % TO 70 % (NOTE2)			
	VOLTAGE	250 V AC	UL.CSA	30V AC					
	CURRENT	2 A		2A					
SPECIFICATIONS									
ITEM		TEST METHOD			REQUIREMENTS			QT	AT
CONSTRUCTION									
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			×	×
MARKING		CONFIRMED VISUALLY.						×	×
ELECTRIC CHARACTERISTICS									
CONTACT RESISTANCE		100 mA (DC OR 1000 Hz).			30 mΩ MAX.			×	—
INSULATION RESISTANCE		500 V DC.			1000 MΩ MIN.			×	—
VOLTAGE PROOF		650 V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			×	—
MECHANICAL CHARACTERISTICS									
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			×	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			×	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.						×	—
ENVIRONMENTAL CHARACTERISTICS									
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→5 TO 35→+85→5 TO 35°C TIME 30→5 TO 15→ 30→5 TO 15min UNDER 5 CYCLES.			① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			×	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 TO 95 %, 96 h.			① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 500 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			×	—
RESISTANCE TO SOLDERING HEAT		1) AUTOMATIC SOLDERING (REFLOW) 《REFLOW AREA》 MAX 240°C WITHIN 10 s MIN 220°C WITHIN 30 s 《PREHEATING AREA》 150°C 100 TO 120 s PUT THROUGH IN REFLOW FUMACE TWICE. LEAVE IN AMBIENT TEMPERATURE AND HUMIDITY FOR 1 HOUR. CONNECTOR TEMPERATURE TO BE AMBIENT FOR SECOND REFLOW. 2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE : 290±10°C, SOLDERING TIME : 3 s NO STRENGTH ON CONTACT.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.			×	—
SOLDERABILITY		SOLDERING TEMPERATURE : 230±5°C SOLDERING TIME : 3 s			A NEW UNIFORM COATING OF SOLDER SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMersed.			×	—
REMARKS					DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT. NOTE2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD,OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION. Unless otherwise specified, refer to JIS C 5402.					F.Matsuki '04.12.28	I.Denpawa '04.12.28	T.Miyazaki '04.12.28	T.Miyazaki '04.12.28	
Note QT:Qualification Test AT:Assurance Test ×:Applicable Test									
HS HIROSE ELECTRIC CO., LTD.					SPECIFICATION SHEET				
CODE NO.(OLD)					PART NO.				
CL					DF11G-*DP-2V (50)				
DRAWING NO.					PART NO.				
ELC4-162244-02					CL543				
					1/1				